

RATING AND CHARACTERISTIC CURVES L09ESD3V3CB2

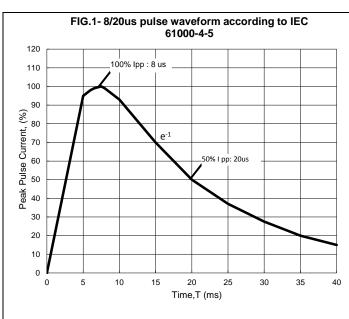


FIG.3- power dissipation versus pulse time

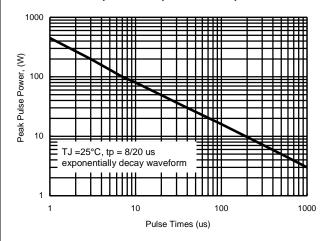


FIG.5- typical junction capacitance

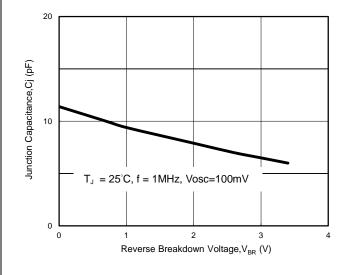
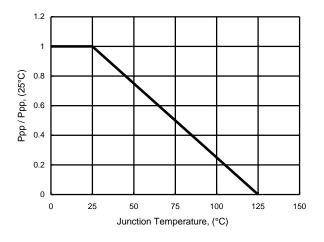
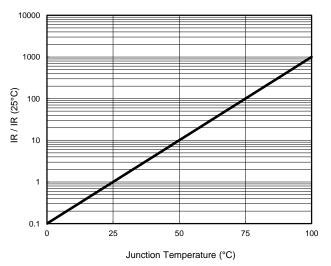


FIG.2- ESD pulse waveform according to IEC 61000-4-2

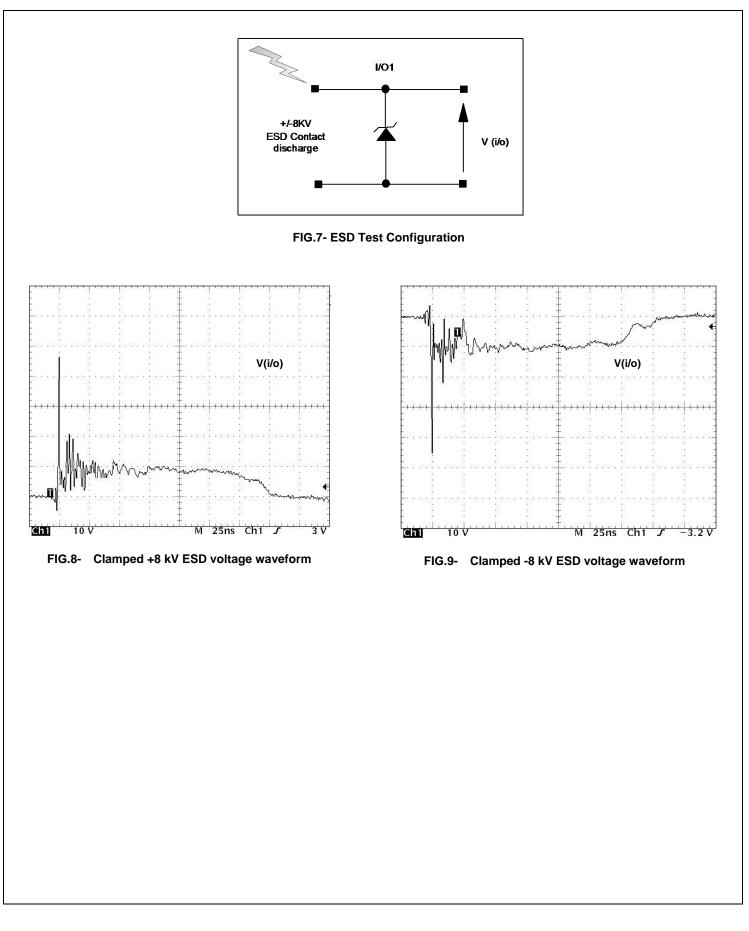
FIG.4- peak pulse power versus Tj







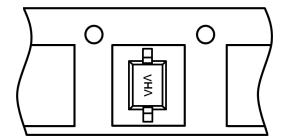
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LITEON



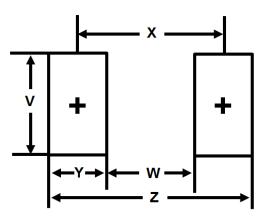
Marking & Orientation



Packaging Information

DEVICE	Q'TY/REEL	REEL DIA.	Q'TY/BOX	Q'TY/CARTON
	(PCS)	(INCH)	(PCS)	(PCS)
L09ESD3V3CB2	3000	7	45000	90K/180K

SOD-323 Soldering Pad Layout



Dim.	MILLIMETERS	INCHES	
Z	3.05	0.120	
Х	2.15	0.084	
W	1.25	0.049	
Y	0.90	0.035	
V	0.70	0.027	



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